# **Transistor-Based Microwave Heaters**

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### **Outline:**

- Introduction
  - Solid-state microwave ovens pioneering studies.
  - High-power RF transistors available today.
- Transistor-based miniature heater
  - Application for biological tests (green-fluorescence protein).
  - Frequency control as a means for an adaptive impedance matching.
  - Active applicator and near-field radiator.
- Open-end applicator (miniature microwave drill)
  - Local melting and erosion of plastic, marble, and glass by transistor-powered applicators.
- Discussion

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### **Microwave Tubes vs. Solid-State Devices**

	<b>RF</b> Transistors	2.45 GHz Magnetrons	
Power	< 150 W	>300 W	
Efficiency	< 40 %	>60 %	
Cost	>1 \$ / W	<0.1 \$ / W	
Voltage	< 60 V	4 kV	
Weight	~0.5 g / W	~5 g / W	
Spectral purity	Good	Poor	

### **Transistor-Based Microwave-Oven History**

- 1969 Erwin F. Belohovbek, "Solid state microwave oven," RCA No. 812, Jan. 1969.
- 1971 Bruce R. McAvoy, "Solid state microwave oven," US patent 3,557,333.
- A. Mackay, W. R. Tinga, and W.A.G. Voss, "Frequency agile sources for microwave ovens," J. Microwave Power 14(1), 1979. [Frequency tuning control as a means for an adaptive matching to varying load].
- 1986 W.A.G. Voss, "Solid state microwave oven development," J. Microwave Power.[Transistor near-field radiator arrays at 915 and 2,450 MHz].

### **Conceptual advantages**

- Adaptive matching by frequency tuning, narrower spectral line width.
- Low-voltage operation, smaller size and weight.
- Modular design by combining radiating elements (power summation).

# **Advanced RF Transistor Technologies**



LDMOS - Lateral Diffused Metal-Oxide Semicond. HBT - Hetero-Junction Bipolar Transistor MESFET - Metal-Semicond. Field-Effect Transistor HEMT - High-Electron Mobility Transistor

The market needs

**300-W transistors** 

@ 1.7-2.2 GHz

and < 1 / W for

cellular applications.

Silicon Carbide Technology -

- Better thermal conductivity than Silicon (4.9 vs. 1.5 W/cm-K).
- Wider band-gap (3.0 vs. 1.1 eV) and higher breakdown field.
- Better immunity but complicated fabrication, defects, etc.

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# **Silicon LDMOS Transistors**

- Mature and reliable fabrication technology.
- Monolithic integration with control circuitry.
- 28-Volt operation, ~100-W output,
  >30% efficiency @ 2.45 GHz.
- Sensitive to electrostatic charge and to reflected waves.
- Commercially available, widely used in cellular base-stations.
- Relatively low-cost (~1 \$ / W).
- A practical choice for miniature heaters.





Heat sink

GATE

DRAIN

n

P - EPI

P<sup>+</sup> - BULK

SOURCE

### **Design Consideration**

- Input and output impedance matching.
- Micro-strip transmission line design.
- Isolation between RF and DC paths.
- Stability.







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### **Examples of Laboratory Solid-State Microwave Sources**



Solid State General Communication Power Amplifier

GCS4Q5EIN

1800 - 2200 MHz / 60 Watt

The GCS4Q5EIN (SKU # 4020) is suitable for high power PCS and UMTS linear applications. This amplifier utilizes advanced silicon LDMOS power devices that provide high gain, wide dynamic range, low distortions and excellent linearity. Exceptional performance, long term reliability and high efficiency are achieved by employing advanced broadband RF matching networks and combining techniques, EMI/RFI filters, machined housings and qualified components. Empower RF's ISO9001 Quality Assurance Program assures consistent performance and the highest reliability.



Shown with Option Package 05

ADVANCED ELECTRONICS TECHNOLOGY http://

http://www.aetjapan.com

Sairem GMM 012 120 W @ 2.45 GHz



Model	APRF100-04-2450	
Frequency	2450MHz	
Input signal	CW/pulse	
Output power	100W (min.)/@12.5W - 100W variable	
Input/Output impedance	Nominal 50 Ω	

### **Miniature Microwave Heater for Biological Tests**

- An applicator for Green-Fluorescence-Protein (GFP) studies\*.
- Non-thermal microwave effect (could be significant to safety standards).
- CW and pulsed microwaves.
- Temperature control up to 40°C, to avoid the protein damage.
- The device shall be embedded in a large optical-biology laboratory setup.

\* Hupert et al., Copty et al.



## **Active Applicator Schemes**



### **Test-Tube Microwave Heater - Oscillator Scheme**



# **Amplifier Experimental Scheme**



Heating a 3-cc test-tube from 23 °C to 100°C (boiling) at ~30 Watt effective microwave power:



#### S11 vs. Frequency at Various Temperatures

- Due to temperature increase, the resonance frequency shifts by >50 MHz.
- A similar shift occurs due to different quantities.
- Frequency tuning during the heating process shortened the time to boil (TTB) by ~40%.
- An adaptive tracking of the resonance during the heating process may improve efficiency.

# Active Applicator Module for Near-Field

## **Ink-Jet Printer Dryer**









In 2002, a magnetron-based solution of a dual slotted waveguide was preferred for this project.

# Miniature Microwave Dryer Head Integrated with Ink Jet ?

- Drop-on-Demand (DoD) ink-jet.
- Microwave-on-Demand (MoD) dryer.
- Synchronized with the drop.
- Compact scheme.
- Enhanced efficiency.
- Could be feasible with RF transistors (not with magnetrons).



### **Application to the Microwave Drill**

### **An Open-End In-Contact Applicator**



Magnetron-based microwave drill





### Transistor-based microwave drills ?

## **Transistor-Based Microwave-Drill Experiments**



Material	P <sub>eff</sub> before melting [W]	P <sub>eff</sub> after melting [W]	TTM [sec]	Drilling speed [mm/sec]
Glass	17.8	34.5	<1	~1
Plastic	18.7	24.8	<1	~1
Marble	24.1	47.9	~3	~0.5

#### TTM – Time To Melt



### Transistor-Based Drilling in a Glass Plate



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### Transistor-Based Drilling in a Tile



# **Microwave Drilling of Bones**

- No rotating / vibrating parts.
- Does not produce debris.
- ~100-W, 2-seocnd operation.
- Immediate fusion of crossing vasculatures.
- Less expensive than any laser drill.
- Next step in vivo experiments.







## **Summary and Discussion**

- There are needs for <200-W heaters, which can be satisfied by transistors.
- Solid-state microwave heaters are more coherent than magnetron, and their frequency can be tuned during the heating process to follow the load variation.
- Transistor-based microwave heaters are compact and controllable. They can be integrated in arrays, and with other electronic circuits.
- Following the radar evolution, the concepts of phased-array antennas, adaptive phased-arrays, and active-antennas, can be adopted for near-field microwave heating. These can be applied also for >200-W systems by power summation.
- Sensing the load response may enable an adaptive spatial power distribution and radiation-pattern synthesis.
- Future developments in communication-oriented technologies may open new possibilities for microwave heating as well.